

Contents

Company Profile...... 3

Microelectronics...... 4

Wafers and Bare Dice (ASSP) Modules, COBs and IC Packaging Custom ASIC Design

Prelaminated Inlays..... 5

LF RFID Prelaminates HF RFID Prelaminates UHF RFID Prelaminates Combined RFID Prelaminates Dual Interface Prelaminates

Flexible Flipchip Inlays.....7

HF RFID Inlays UHF RFID Inlays Dual Frequency RFID Inlays Paper Substrate RFID Inlays Graphene Antenna RFID Inlays White PET RFID Inlays

Flexible RFID Transponders......8

Adhesive (Wet) Inlays RFID Labels On Metal RFID Labels RFID Tickets RFID Paper Tags RFID Clothing Tags

Standard RFID Transponders...... 10

ISO Cards RFID Key Fobs and Clamshell Cards RFID Tokens Coil and Module (Clear Tags) PCB Tags FPC Tags RFID Wearables

Industrial RFID Transponders...... 12

Rugged RFID Tags Rugged On Metal RFID Tags RFID Disc Tags RFID Waste Bin Tags LF/HF Laundry Tags UHF Laundry Tags Tamper-evident Seal Tags Tamper-resistant Seal Tags Mini Bullet Tags

Biometric RFID..... 15

Fingerprint Cards Fingerprint Prelaminated Inlays

ENEFCY (NFC Tags)..... 16

NFC Labels Epoxy Tags NFC Wristbands NFC Buttons LED NFC Tags NFC Posters

BIELEE (BLE Tags)..... 18

BLE Tags / iBeacons

Smart Sensing IOT loggers...... 19

NFC T°Tag Temperature Loggers Dual RFID T°Tag Temperature Loggers RFID T°Tag Temperature Logger Labels Smart Sensing IOTag Loggers Smart Sensing IOT Card Loggers Smart Sensing LoRa IOTag Loggers

RFID Readers..... 21

LF RFID Reader Module HF RFID Reader Module URA Mini (Mobile UHF Reader) URA Blue (Bluetooth UHF Reader) URA One (All-in-one UHF Reader) URA Multi (4-Channel UHF Reader)

Custom Products Development.... 23

Custom Antenna and Transponder Custom Housing Custom Device Architecture

Antenna (Catal	ogue	25
-----------	-------	------	----

Contacts	32
----------	----



Company Profile



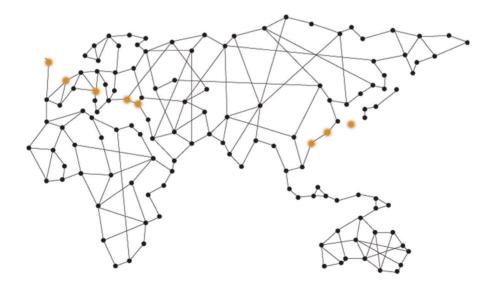
@RFID is a privately owned international group, having establishments in Bulgaria, China, France, Germany, Hong Kong, Taiwan, Turkey and the UK. Further to its constant development and growth and its ambition for technology leadership, the company is targeting an IPO by 2020.

With two R&D centers and four factories, @RFID is mastering RFID and contactless technologies from conception and design to all stages of manufacturing and production.

The innovation and the quality are fundamental in the corporate strategy and drive a continuous investment in cutting edge equipment and talent recruitment, enabling a unique market positioning and an ever-growing business in the emerging IOT sector.

Truly international, @RFID benefits from its local involvement in different countries where its presence is constantly enforced, while pursuing its strategy of global development with new establishments in new business zones, targeting a worldwide leadership in IOT, RFID and contactless technologies.

Founded in 2007, @RFID celebrates its 10th anniversary in 2017, a record-braking year for the company and a starting point of a further stage of development.



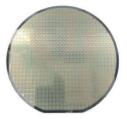
Microelectronics



Through the years, @RFID gathered a valuable expertise in semiconductors and microelectronics and established strong partnerships with some of the world leading foundries. This unique situation is translated into comprehensive offer for ASSP ICs, packaging services and custom ASIC design and production.

Wafers & Bare Dice ASSP

Features: Standard RFID memory ICs Available ICs: Low frequency 125 kHz High frequency 13.56 MHz Contact chips



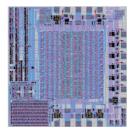
Modules, COBs and IC Packaging

Features: ICs Packaging services Available packages: COB Module Contact module QFN



Custom ASIC Design

Features: On demand design Available technologies: Digital and analog ICs



Prelaminated Inlays



@RFID Prelaminates are dedicated to card manufacturing, providing high quality technology core. The complex multilayer structure based on PVC, PET or PC substrates varies in thickness. The middle layer incorporates the transponders consisting of wired antenna and chip module. The transponders have various designs and can be aligned for different layouts. In addition there can be a layout print, reference angle mark, product reference and production date stamping.

LF RFID Prelaminates

Operating frequency: 125-134 KHz Available ICs: EM, NXP, Atmel, @RFID Compatible LF Chip connection/packaging: COB/Module bonding Substrate: PVC Antenna material: Copper wire Antenna shape: Circular/Oval Sizes and layout: Up to 550x700 mm Thickness: From 500 to 650 microns



HF RFID Prelaminates

Operating frequency: 13.56 MHz Standard: ISO 14443, ISO 15693 Available ICs: NXP, Infineon, ST Micro, @RFID Chip connection/packaging: COB/Module bonding Substrate: PVC/PET/PC Antenna material: Copper wire Antenna shape: Rectangular/Customizable Sizes and layout: Up to 550x700 mm Thickness: From 300 to 650 microns



UHF RFID Prelaminates

Operating frequency: 840-960 MHz Available ICs: NXP UCODE, Impinj Monza, Alien Higgs Chip connection/packaging: Bare die flipchip Substrate: PVC/PET Antenna material: Etched Aluminium Antenna shape: See Antenna Catalogue (page 25) Sizes and layout: Up to 550x700 mm Thickness: From 300 to 500 microns



Combined RFID Prelaminates

Combinations: LF+HF/HF+UHF/LF+HF+UHF Operating frequency: 125-134KHz/13.56MHz/840-960MHz Available ICs: EM, Atmel, NXP, Infineon, ST, Impinj, Alien Chip connection/packaging: COB bonding, Bare die flipchip Substrate: PVC/PET Antenna material: Copper wire, Etched Aluminium Sizes and layout: Up to 550x700 mm Thickness: From 350 to 500 microns



Dual Interface Prelaminates

Operating frequency: 13-14 MHz Connection Interface: Zig-Zag wire, Copper plates, Inductive coupling Suitable for: Infineon, ST Micro, NXP Substrate: PVC/PET/PC Antenna material: Copper wire, Alloy wire Sizes and layout: Up to 550x700 mm Thickness: From 150 to 500 microns



Flexible Flipchip Inlays



@RFID Flexible Flipchip Inlays are designed for label converting and tag manufacturing, providing high technology core layer for high frequency or ultra-high frequency RFID tags. Based on flexible PET substrate with etched aluminium or copper antenna, the chip is assembled by cutting edge flipchip equipment. The inlays may integrate various antenna designs and chips, suitable for any application. The product is delivered on roll in multiple or single line.

HF RFID Inlays

Operating frequency: 13.56 MHz Standard: ISO 14443, ISO 15693 Available ICs: NXP, Infineon, ST Micro, @RFID Compatible HF Chip connection/packaging: Bare die Flipchip Substrate: PET Antenna material: Etched Aluminium, Etched Copper Form factor: Multiline/Single line roll



UHF RFID Inlays

Operating frequency: 840-960MHz Available ICs: NXP UCODE Series, Impinj Monza Series, Alien Higgs Series Chip connection/packaging: Bare die Flipchip Substrate: PET Antenna material: Etched Aluminium, Etched Copper Form factor: Multiline/Single line roll



MORE Inlays

Dual Frequency RFID Inlays Paper Substrate RFID Inlays Graphene Antenna RFID Inlays White PET RFID Inlays



Flexible **RFID** Transponders



@RFID Felxible transponders are designed for printing, personalisation or direct application. Based on high technology core layer of high frequency (NFC) or ultrahigh frequency (UHF) RFID dry inlays, these products are additionnaly going through converting processes by high precision equipement applying adhesive material and liner, as well as optional frontal surface. Various materials are available to suit any application or printing equipment.

Adhesive (Wet Inlays

Operating frequency: 13.56 MHz/840-960 MHz Available ICs: NXP, Infineon, ST, @RFID Compatible HF, Alien, Impinj Chip connection/packaging: Bare die flipchip Substrate: PET with Adhesive and Release paper Antenna material: Etched Aluminium, Etched Copper Form factor: Multiline/Single line roll

RFID Labels

Operating frequency: 13.56 MHz/ 840-960 MHz Available ICs: NXP, Infineon, ST Micro, @RFID Compatible HF, Alien, Impinj Chip connection/packaging: Bare die flipchip Substrate: PET with Adhesive on Release paper with Frontal Paper/PVC/PET/PP Antenna material: Etched Aluminium, Etched Copper Form factor: Multiline/Single line roll



On Metal RFID Labels

Operating frequency: 13.56 MHz/840-960 MHz Available ICs: NXP, Infineon, ST Micro, @RFID Compatible, Alien, Impinj Chip connection/packaging: Bare die flipchip Substrate: PET with Adhesive on Release paper with Frontal Paper/PVC/PET/PP Metal Insulation Layer: Ferrite/Foam/Aluminium foil Antenna material: Etched Aluminium, Etched Copper Form factor: Multiline/Single line roll



RFID Tickets

Operating frequency: 13.56 MHz, 840-960 MHz **Available ICs:** NXP, Infineon, ST Micro, @RFID Compatible HF, Alien, Impinj

Chip connection/packaging: Bare die Flipchip Substrate: PET inlay within Paper encapsulation Antenna material: Etched Aluminium, Etched Copper

Form factor: Roll, Fan-fold, Piece by piece



Operating frequency: 13.56 MHz, 840-960MHz Available ICs: NXP, Infineon, ST Micro, @RFID Compatible HF, Alien, Impinj Chip connection/packaging: Bare die flipchip Substrate: PET inlay within Paper encapsulation Antenna material: Etched Aluminium, Etched Copper Earm factor: Poll, Ean fold, Piaco by piaco

Form factor: Roll, Fan-fold, Piece by piece



Operating frequency: 13.56 MHz, 840-960MHz **Available ICs:** NXP, Infineon, ST Micro, @RFID Compatible HF, Alien, Impinj

Chip connection/packaging: Bare die Flipchip Substrate: PET inlay within paper encapsulation Antenna material: Etched Aluminium, Etched Copper

Form factor: On roll or piece by piece Features: Perforation, hanging string





Standard RFID Transponders



@RFID standard RFID transponders are versatile products with proven quality that follow strictly the ISO requirements for form factor, durability and performance. Cost effective and reliable, they can be ready to use or can offer a perfect solution for integration within any RFID application.

ISO Cards

Standard: LF/HF/UHF/Combined Operating frequency:125KHz/13.56MHz/860-960MHz Available ICs: EM, NXP, Infineon , ST Micro, @RFID Compatible, Impinj, Alien Chip connection/packaging: COB Module, Bare die Flipchip Substrate: PVC, PET Antenna material: Copper wire Etched Aluminium Form factor: ISO Standard

RFID Key Fobs and Clamshell Cards

Standard: LF/HF Available ICs: EM, NXP, Infineon , ST, @RFID Compatible Chip connection/packaging: COB Module, Bare die Flipchip Housing Material: ABS Shell Antenna material: Copper wire Form factor: @RFID KF Shell/Clamshell standard housing





RFID Tokens

Standard: LF/HF Available ICs: EM, NXP, Infineon, ST Micro, @RFID Compatible HF Chip connection/packaging: COB Module Substrate: ABS Shell Antenna material: Copper wire Form factor: Various token shapes



Coil and Module (Clear Tags)

Standard: LF/HF Available ICs: EM, NXP, Infineon, ST Micro, @RFID Compatible Chip connection/packaging: COB Module Antenna material: Copper wire Form factor: Various antenna shapes and sizes



PCB Tags

Operating frequency: 13-14 MHz/860-960 MHz **Available ICs:** NXP, ST Micro, @RFID Compatible Range, Impinj, Alien

Chip connection/packaging: Direct bonding, SMT Substrate: PCB

Antenna material: Etched aluminium or copper Form factor: Various antenna shapes and sizes

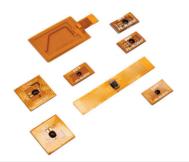


FPC Tags

Operating frequency: 13-14 MHz/860-960 MHz **Available ICs:** NXP, Infineon , ST Micro, @RFID Compatible, Impinj, Alien

Chip connection/packaging: Direct bonding, SMT Substrate: FPC

Antenna material: Etched aluminium or copper Form factor: Various antenna shapes and sizes



RFID Wearables

Standard: LF/HF/UHF Available ICs: EM, NXP, Infineon ST Micro, @RFID Compatible, Impinj, Alien Chip connection/packaging: COB Module, Bare die flipchip Material: Silicon, PVC, Fabric Antenna material: Copper Wire, Etched Aluminium Form factor: Various shapes and form factors





Industrial RFID Transponders



@RFID Industrial RFID Transponders are specifically designed to withstand harsh environment and extreme temperature and suite various industrial applications. The integrated RFID units are protected by custom developed highly resistant housings in various shapes, sizes and features for different usages.

Rugged RFID Tags

Operating frequency: 125-134 KHz/13-14 MHz/ 860-960 MHz Available ICs: EM, NXP, Infineon, ST Micro, @RFID Compatible HF, Impinj, Alien Chip connection/packaging: COB Module Housing Material: PCB, PPS, Epoxy Antenna material: Copper wire, Etched Aluminium, Etched Copper Form factor: Various shapes and form factors



Rugged On Metal RFID Tags

Operating frequency: 125-134 KHz/13-14 MHz/ 860-960 MHz Available ICs: EM, NXP, Infineon, ST Micro, @RFID Compatible, Impinj, Alien Chip connection/packaging: COB Module Housing Material: ABS, PPS Antenna material: Copper wire, Etched Aluminium, Etched Copper Form factor: Various shapes and form factors



RFID Disc Tags

Operating frequency: 125-134 KHz/13-14 MHz/ 860-960 MHz Available ICs: EM, NXP, Infineon, ST Micro, @RFID Compatible, Impinj, Alien Chip connection/packaging: COB Module Housing Material: ABS, PPS Antenna material: Copper wire, Etched Aluminium, Etched Copper Form factor: Various shapes and form factors



RFID Waste Bin Tags

Operating frequency: 125-134 KHz, 13-14 MHz Available ICs: EM, NXP, Infineon, ST Micro, @RFID Compatible Chip connection/packaging: COB Module Housing material: ABS, PPS Antenna material: Copper Wire Form factor: Screw shape



LF/HF Laundry Tags

Operating frequency: 125-134 KHz, 13-14 MHz Available ICs: EM, NXP, Infineon, ST Micro, @RFID Compatible Chip connection/packaging: COB Module Housing Material: ABS, PPS Antenna material: Copper wire Form factor: Circular



UHF Laundry Tags

Operating frequency: 840-960 MHz Available ICs: NXP, Impinj , Alien Chip connection/packaging: COB Module, Inductive coupling Surface Material: High durability fabric Antenna material: Alloy Wire Form factor: Rectangular

Tamper-evident Seal Tags

Operating frequency: 125-134 KHz, 13-14 MHz Available ICs: EM, NXP, Infineon, ST Micro, Silicon Craft, @RFID Compatible Chip connection/packaging: COB Module Housing Material: ABS, Nylon Antenna material: Copper wire Form factor: Lockable single use tamper-evident seal



Tamper-resistant Seal Tags

Operating frequency: 13-14 MHz/860-960 MHz Available ICs: NXP, Infineon, ST Micro, @RFID Compatible, Impinj, Alien Chip connection/packaging: Bare die flipchip Housing Material: ABS, Nylon Antenna material: Etched Aluminium or Copper Form factor: Lockable single use tamper-resistant seal

Mini Bullet Tags

Operating frequency: 13-14 MHz Available ICs: NXP, Infineon, ST Micro, @RFID Compatible Chip connection/packaging: COB Module Base Material: Ferrite Antenna material: Copper Wire Form factor: Cylinder "bullet" shape



Biometric RFID



@RFID Biometric RFID product range translates the latest R&D results in the field of secure identification. Battery assisted and equipped with high precision fingerprint sensor, the Biometric RFID transponders enable a unique authentication process prior to the RFID communication, while its core antenna and chip are based on FPC substrate, whose reliability and performance are proven. A further process of hot lamination provides the needed resistance and follows strictly the ISO standards.

Fingerprint Cards

Operating frequency: 13.56 MHz Available ICs: NXP, Infineon, ST Micro, @RFID Compatible Chip connection/packaging: Direct bonding, SMT Substrate: FPC, PVC Antenna material: Etched copper Form factor: ISO Size



Fingerprint Prelaminated Inlays

Operating frequency: 13.56 MHz Available ICs: NXP, Infineon, ST Micro, @RFID Compatible Chip connection/packaging: Direct bonding, SMT Substrate: FPC, PVC Antenna material: Etched copper Size and layout: Up to 550x700 mm Thickness: From450 to 600 microns

	•	•	•
		•	

ENEFCY (NFC Tags)



@RFID ENEFCY product range is designed for any NFC and mobile based applications. The proven high frequency RFID technology is here enhanced by high-end enclosing and housing materials and sophisticated design, making the products ergonomic, durable, user friendly and high quality. Further innovations and ingenious solutions offer wide application possibilities.

NFC Labels

Operating frequency: 13.56 MHz Available ICs: NXP, ST Micro, @RFID Compatible Chip connection/packaging: Bare die Flipchip Substrate: PET with Adhesive on Release paper with Frontal Paper/PVC/PET/PP Antenna material: Etched Aluminium, Etched Copper Form factor: On roll / Piece by piece



Epoxy Tags

Operating frequency: 13.56 MHz Available ICs: NXP, ST Micro, @RFID Compatible HF Range Chip connection/packaging: COB Module Substrate: PVC core with Epoxy doming Antenna material: Copper Wire Form factor: Various shapes and sizes



NFC Wristbands

Operating frequency: 13.56 MHz Available ICs: NXP, ST Micro, @RFID Compatible Chip connection/packaging: COB Module Base Material: PVC core, Fabric band Antenna material: Copper Wire Form factor: Various shapes and sizes Close: Single or multiple use



NFC Buttons

Operating frequency: 13.56 MHz Available ICs: NXP, ST Micro, @RFID Compatible HF Range Chip connection/packaging: COB Module Substrate: PET, PVC Antenna material: Etched Aluminium Form factor: Various shapes, sizes and constructions



LED NFC Tags

Operating frequency: 13.56 MHz Available ICs: NXP, ST Micro, @RFID Compatible + LED Chip connection/packaging: COB Module Substrate: PVC, Epoxy doming Antenna material: Copper Wire Form factor: Various shapes and sizes



NFC Posters

Operating frequency: 13.56 MHz Available ICs: NXP, ST Micro, @RFID Compatible Chip connection/packaging: COB Module Substrate: PVC Antenna material: Copper wire Size and layout: Various sheet sizes



BIELEE (BLE Tags)



@RFID BIELEE product range is designed for Bluetooth and iBeacon mobile based applications. Based on a high quality PCB technology, assembled by SMT, the products are enclosed in high quality resistant housing materials providing sophisticated design and making the products durable, user friendly and high quality.

BLE Tags

Standard: Bluetooth Low Energy Available ICs: Nordic ID, ST Micro Chip connection/packaging: SMT Material: PCB/ABS Housing Antenna material: Etched Copper Form factor: Various housing



Smart Sensing IOT Loggers



@RFID Smart Sensing IOTags are resulting from years of intense R&D work and high market demand. They incorporate various contactless communication interfaces, including high and ultra high frequency RFID (NFC and UHF), BLE and LoRa, while the smart sensors can measure temperature, humidity, shock or movement. Passive or battery assisted (loggers), the IOTags can have different form factors, from highly resistant rugged devices to flexible labels.

NFC T°Tag Temperature Loggers

Interface: NFC (frequency: 13.56MHz) Available ICs: NXP, AMS Sensor: On-chip temperature sensor Chip connection/packaging: SMT Material: PCB/ABS Housing Antenna material: Etched Copper Form factor: ABS Shell, various shapes Supply voltage: RF field or 1.2 to 3.3V Visual Indication: LED, Electro chromatic display

Dual RFID T°Tag Temperature Loggers

Interface: Dual NFC + UHF (13.56 and 860-960 MHz) Available ICs: NXP, AMS Sensor: On-chip temperature sensor Chip connection/packaging: SMT Material: PCB/ABS Housing Antenna material: Etched Copper, Chip antenna Form factor: ABS Shell, Epoxy molding Supply voltage: RF field or 1.2 to 3.3v Visual Indication: LED, Electro chromatic display



RFID T°Tag Logger Labels

Interface: NFC and UHF dual RFID Standard: 13.56 and 860-960 MHz Chips: AMS, NXP Sensor: On-chip temperature sensor Chip connection/packaging: COB + Pick and Stamping Substrate: PET, Adhesive with Frontal PET/PP Antenna material: Etched Aluminium Form factor: Label Supply voltage: RF field or 1.2 to 3.3v



Smart Sensing IOTag Loggers

Interface: NFC and BLE Available ICs: ST Micro, Nordic ID Sensor: External Temperature & Humidity, Accelerometer Chip connection/packaging: SMT Material: PCB/ABS Housing Antenna material: Etched Copper Form factor: ABS Shell, Epoxy molding Supply voltage: RF field or 1.2 to 3.3v Visual Indication: LED, Electro chromatic display

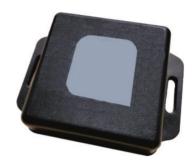
Smart Sensing IOT Card Loggers

Interface: NFC, UHF and BLE Available ICs: ST Micro, Nordic ID Sensor: External Temperature & Humidity, Accelerometer Chip connection/packaging: SMT Material: FPC/Hot laminated PVC Antenna material: Etched Copper Form factor: ABS Shell, Epoxy molding Supply voltage: RF field or 1.2 to 3.3v Visual Indication: LED, Electro chromatic paper display

Smart Sensing LoRa IOTag Loggers

Interface: NFC, BLE and LoRa Available ICs: ST Micro, Nordic ID Sensor: External Temperature & Humidity, Accelerometer Chip connection/packaging: SMT Material: PCB/ABS Housing Antenna material: Etched Copper Form factor: ABS Shell, Epoxy molding Supply voltage: 3.3V battery, 12V plug-in Visual Indication: LED, Electro chromatic paper display







RFID Readers



@RFID offers a complete range of quality RFID readers, from basic reader modules to high-end performant connected devices, dedicated to different applications and usages. Along with the products and the attentionate after-sales service, a further integration support can be provided by local technology partners and integrators.

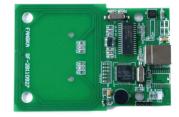
LF RFID Reader Module

Standard: LF Operating frequency: 125 KHz Supported ICs: EM, Atmel, Compatible Assembly: SMT Material: PCB Antenna material: Wired Copper Reading range: Up to 10 cm Interface/ Power supply: DC, USB SDK: Win32, Win64 SDK



HF RFID Reader Module

Standard: HF (NFC) Operating frequency: 13.56 MHz MCU: ARM 32-bit Cortex Supported ICs: NXP, ST Micro, Infineon, Compatible Assembly: SMT Material: PCB Antenna material: Etched Copper Reading range: Up to 10 cm Interface/Power supply: DC, USB



URA Mini (Mobile UHF Reader)

Standard: UHF (frequency: 860-960 MHz) Supported ICs: NXP, Alien, Impinj Supported platforms: Android, iOS Assembly: SMT Material: PCB/ABS Housing Form factor: Mobile accessory Reading range: Up to 50 cm Interface: 3.5 mm Audio jack Power supply: USB



URA Blue (Bluetooth UHF Reader)

Interface: UHF (frequency: 860-960 MHz) UHF Module: Impinj R2000 Supported ICs: NXP, Alien, Impinj Supported platforms: PC (Win/Mac), Mobile (Android/iOS) Form factor: Handheld racket RF output: 0-30 dBm, 1 dB / Step Battery: 3000 mAh Li-ion Reading range: Up to 10 m Visual Indication: 1.3 inch OLED LCD display

URA One (All-in-one UHF Reader)

Interface: UHF (frequency: 860-960 MHz) Processor: ARM Cortex M3, 100M Supported ICs: NXP, Alien, Impinj Supported interfaces: Ethernet, RS232, RS485, Wiegand Material: PCB/ABS Housing Configuration: All-in-one, Integrated antenna RF output: 0-31 dBm Power supply: DC 9-15V Reading range: Up to 7 m



-

URA Multi (4 Channel UHF Reader)

Interface: UHF (frequency: 860-960 MHz) Processor: ARM Cortex M3, 100M Supported ICs: NXP, Alien, Impinj Supported interfaces: Ethernet, RS232, RS485, Wiegand Material: PCB/ABS Housing Form factor: Metal box Antenna output: Up to 4 antennas RF output: 0-31 dBm Power supply: DC 9-15V Reading range: Up to 10 m



Custom Products Development



@RFID has strong R&D capabilities and extended know-how in RFID, IOT and contactless technologies, combined with fully integrated production facilities, providing a competitive advantage for innovation and design. With its dedicated team, the company is eager to undertake any challenge for custom product development, following particular customer and application requirements.

Custom Antenna and Transponder

Standard: LF, HF (NFC), UHF RFID Available ICs: EM, NXP, ST Micro, Infineon, @RFID Compatible, Alien, Impinj Chip connection/packaging: COB Module, Bare die flipchip, SMT Substrate/Material: Coil, PET film, PCB Antenna material: Wired copper, Etched Aluminium or Copper Form factor: Custom



Custom Housing

Material: PVC, PET, PP, PC, ABS, Silicon, Nylon, Wood, Metal, Composite Shapes & sizes: Custom design, various configurations Special features: IP resistance, custom application purpose functionalities Mold and sampling: 3D print, CNC Production and Assembly : Converting, Lamination, Gluing, Ultrasonic welding, Molding, Injection, Doming, Encapsulation



Custom Device Architecture

Standard: RFID, BLE, LoRa, WiFi Optional: Smart Sensors, Custom connectivity Chip connection/packaging: COB Module, Bare die flipchip, SMT Substrate/Material: Coil, PET film, PCB, optional converting, lamination or housing Form factor: Custom Supply voltage: RF field, Integrated battery, Power supply Optional visual Indication: LED, Displays







DA 3102	Features
Inlay	78×47 mm
Antenna	76×45 mm
Frequency	13.5-14.5 MHz
Read range	≥5 cm
Protocol	ISO 15693
Chips	NXP I-code Series



DA 3110	Features	
Inlay	42×27 mm	
Antenna	40×25 mm	
Frequency	13.8-14.2 MHZ	
Read range	6-8 cm	
Protocol	ISO 15693	
Chips	NXP I-code Series	



DA 3112	Features
Inlay	Φ24 mm
Antenna	Φ22 mm
Frequency	13.8-14.2 MHz
Read range	5-7 cm
Protocol	ISO 15693
Chips	NXP I-code Series



DA 3108	Features
Inlay	Φ27 mm
Antenna	Φ25 mm
Frequency	14-14.4 MHz
Read range	≥2 cm
Protocol	ISO 15693
Chips	NXP I-code Series



DA 3111	Features
Inlay	13.5x13.5 mm
Antenna	11.5x11.5 mm
Frequency	13.8-14.0 MHZ
Read range	≥2 cm
Protocol	ISO 15693
Chips	NXP I-code Series



DA 3113	Features	
Inlay	Φ15 mm	
Antenna	Φ13 mm	
Frequency	16.9-17.1 MHZ	
Read range	≥2 cm	
Protocol	ISO 15693	
Chips	NXP I-code Series	



DA 3116	Features
Inlay	47×47 mm
Antenna	45×45 mm
Frequency	13.8-14.2 MHz
Read range	6-8 cm
Protocol	ISO 15693
Chips	NXP I-code Series



DA 3125	Features
Inlay	28x15 mm
Antenna	26x11 mm
Frequency	13.7-13.9 MHz
Read range	≥3 cm
Protocol	ISO 15693
Chips	NXP Icode Series



DA 3218	Features
Inlay	25×20 mm
Antenna	23×18 mm
Frequency	13.5-14.5 MHz
Read range	≥2 cm
Protocol	ISO 14443 A
Chips	NXP Mifare Series/ Fudan08



DA 3117	Features
Inlay	38×10 mm
Antenna	36×8 mm
Frequency	13.9-14.1 MHZ
Read range	≥3 cm
Protocol	ISO 15693
Chips	NXP I-code Series



DA 3206	Features
Inlay	77x45 mm
Antenna	75x43 mm
Frequency	13.5-14.5 MHz
Read range	≥5 cm
Protocol	ISO 14443 A
Chips	NXP Mifare Series /Fudan08



DA 3258	Features
Inlay	Φ17.8 mm
Antenna	Φ15.8 mm
Frequency	13.8-14.2 MHz
Read range	2-3 cm
Protocol	ISO 14443A
Chips	NXP Mifare Series/ Fudan08



DA 3222	Features
Inlay	Φ37 mm
Antenna	Φ35 mm
Frequency	13.5-14.5 MHz
Read range	≥4 cm
Protocol	ISO 14443A

Chips

NXP Mifare Series /Fudan08



DA 3228	Features
Inlay	77x45 mm
Antenna	75×43 mm
Frequency	13.5-14.5 MHz
Read range	≥5 cm
Protocol	ISO 14443 A NXP NTAG Series /@RFID
Chips	Compatible Series



DA 3238	Features
Inlay	Φ24 mm
Antenna	Φ22 mm
Frequency	13.5-14.5 MHz
Read range	≥2 cm
Protocol	ISO 14443 A NXP NTAG Series /@RFID
Chips	Compatible Series



DA 3226	Features
Inlay	Φ22 mm
Antenna	Φ20 mm
Frequency	13.5-14.5 MHz
Read range	2-3 cm
Protocol	ISO 14443A
Chips	NXP Mifare Series /Fudan08



DA 3231	Features
Inlay	17 mm
Antenna	15 mm
Frequency	13.5-14.5 MHz
Read range	≥5 cm
Protocol	ISO 14443 A NXP NTAG Series /@RFID
Chips	Compatible Series



DA 3250	Features
Inlay	Φ27 mm
Antenna	Φ25 mm
Frequency	13.8-14.2 MHZ
Read range	2 - 3 cm
Protocol	ISO 14443 A
Chips	NXP Mifare Series /Fudan08

\bigcirc



DA 3256	Features
Inlay	Ф39 mm
Antenna	Ф37 mm
Frequency	13.8-14.2 MHZ
Read range	3-5 cm
Protocol	ISO 14443 A NXP NTAG Series / ST /
Chips	@RFID Compatible Series



DA 3262	Features
Inlay	42×42 mm
Antenna	40×40 mm
Frequency	13.8-14.2 MHz
Read range	6-8 cm
Protocol	ISO 14443A NXP NTAG Series / ST /
Chips	@RFID Compatible Series



DA 4221	Features
Inlay	45x23 mm
Antenna	43x21 mm
Frequency	860-960 MHz
Read range	≥5 m
Protocol	ISO18000-6C/EPC Gen2
Chips	NXP U-code Series

DA 3260	Features
Inlay	10×20 mm
Antenna	8×18 mm
Frequency	13.8-14.2 MHz
Read range	1-2 cm
Protocol	ISO 14443A NXP NTAG Series / ST /
Chips	@RFID Compatible Series



DA 4201	Features
Inlay	74x18 mm
Antenna	73x17 mm
Frequency	902 MHz - 928 MHz
Read range	Up to 10 m
Protocol	ISO18000-6C/EPC Gen2
Chips	NXP U-code Series



DA 4243	Features
Inlay	50x30 mm
Antenna	52x32 mm
Frequency	860 – 960 MHz
Read range	Up to 10 m
Protocol	ISO18000-6C/EPC Gen2
Chips	NXP U-code Series

DA 6201	Features
Inlay	73×21 mm
Antenna	71×19 mm
Frequency	860-960 MHz
Read range	≥6 m
Protocol	ISO18000-6C/EPC Gen2
Chips	Alien Higgs Series



DA 6218	Features
Inlay	24.5×24.5mm
Antenna	22.5×22.5mm
Frequency	860-960 MHz
Read range	≥3.5 m
Protocol	ISO18000-6C/EPC Gen2
Chips	Alien Higgs Series





DA 6220	Features
Inlay	46x46 mm
Antenna	44x44 mm
Frequency	860-960 MHz
Read range	≥6 m
Protocol	ISO18000-6C/EPC Gen2
Chips	Impinj Monza 4 Series



DA 6239	Features
Inlay	24×10 mm
Antenna	22×8 mm
Frequency	860-960 MHz
Read range	≥0.3 m
Protocol	ISO18000-6C/EPC Gen2
Chips	Impinj Monza Series

DA 6263	Features
Inlay	14x11 mm
Antenna	12×9 mm
Frequency	860-960 MHz
Read range	≥0.2 m
Protocol	ISO18000-6C/EPC Gen2
Chips	Alien Higgs Series



Inlay	96x5 mm
Antenna	94x3 mm
Frequency	860-960 MHz
Read range	≥3 m
Protocol	ISO18000-6C/EPC Gen2
Chips	Alien Higgs Series



DA 6275	Features
Inlay	72×52 mm
Antenna	70×50 mm
Frequency	860-960 MHz
Read range	≥6 m
Protocol	ISO18000-6C/EPC Gen2
Chips	Impinj Monza R6 Series



DA 6285	Features
Inlay	42x17 mm
Antenna	40×15 mm
Frequency	860-960 MHz
Read range	≥4 m
Protocol	ISO18000-6C/EPC Gen2
Chips	Alien Higgs Series



DA 6277	Features
Inlay	Φ12 mm
Antenna	Φ10 mm
Frequency	860-960 MHz
Read range	≥0.3 m
Protocol	ISO18000-6C/EPC Gen2
Chips	Impinj Monza R6 Series

CONTACTS

BULGARIA

Unit 521, Building C1 Bantian International Center Longgang District, Shenzhen, China Tel: +86 186 88 34 82 72 E-mail: shenzhen@arfid.eu

FRANCE

Adlerstr.2 63322 Rodermark, Germany Tel:+ 49 152 05 11 56 14 Fax: +49 321 28 61 92 90 E-mail: frankfurt@arfid.eu

HONG KONG

No.25, Sec. 3, Fuxing Rd, Xinzhuang Dist. 24251 New Taipei City, Taiwan Tel: + 886 2 2276 1680 Fax: +886 2 2276 0227 E-mail: taipei@arfid.eu

TURKEY

14, Western Gateway E16 1BN London, United Kingdom Tel: +33 1 40 86 80 03 Fax: +33 9 83 40 80 03 E-mail: london@arfid.eu Blvd. Tsarigradsko Shose 135D, 1784 Sofia, Bulgaria Tel: +359 2 440 03 58 Fax: +359 2 884 55 82 E-mail: sofia@arfid.eu

CHINA

113, Rue Victor Hugo, 92300 Levallois-Perret, France Tel: +33 1 40 86 80 03 Fax: +33 9 83 40 80 03 E-mail: paris@arfid.eu

GERMANY

Unit 1605 Boss Commercial Center. 28 Ferry Street, Kowloon, Hong Kong Tel: +852 27 36 9818 Fax: +852 2736 3277 E-mail: hongkong@arfid.eu

TAIWAN

Burgaz Cda. No.71 Kumburgaz/Buyukcekmece, 34530 Istanbul, Turkey Tel: +90 533 529 65 35 E-mail: istanbul@arfid.eu

UNITED KINGDOM



www.arfid.eu